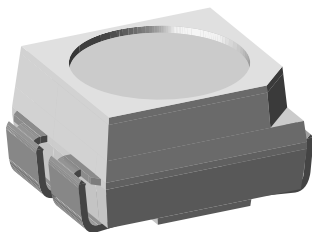


Bicolor SMD LED PLCC-4



19211

DESCRIPTION

These devices have been designed to meet the increasing demand for surface mounting technology.

The package of the VLMKE3400 is the PLCC-4.

It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled up with clear epoxy.

This SMD device consists of a red and yellow chip. So it is possible to choose the color in one device.

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD PLCC-4
- Product series: bicolor
- Angle of half intensity: $\pm 60^\circ$

FEATURES

- SMD LED with exceptional brightness
- Multicolored
- Luminous intensity categorized
- EIA and ICE standard package
- Compatible with automatic placement equipment
- Suitable for IR reflow and TTW soldering
- Available in 8 mm tape
- Low profile package
- Non-diffused lens: excellent for coupling to light pipes and backlighting
- Low power consumption
- Luminous intensity ratio in one packaging unit $I_{Vmax}/I_{Vmin} \leq 1.6$
- JEDEC® level 4
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

APPLICATIONS

- Telecommunication: indicator and backlighting in telephone and fax
- Indicator and backlight for audio and video equipment
- Indicator and backlight in office equipment
- Flat backlight for LCDs, switches, and symbols
- General use

PARTS TABLE

| PART | COLOR | LUMINOUS INTENSITY (mcd) | | | at I _F (mA) | WAVELENGTH (nm) | | | at I _F (mA) | FORWARD VOLTAGE (V) | | | at I _F (mA) | TECHNOLOGY |
|----------------|--------|--------------------------|------|------|------------------------|-----------------|------|------|------------------------|---------------------|------|------|------------------------|-----------------|
| | | MIN. | TYP. | MAX. | | MIN. | TYP. | MAX. | | MIN. | TYP. | MAX. | | |
| VLMKE3400-GS08 | Red | 56 | - | 180 | 20 | - | 630 | - | 20 | - | 1.9 | 2.6 | 20 | AlInGaP on GaAs |
| VLMKE3400-GS08 | Yellow | 90 | - | 280 | 20 | 581 | 588 | 594 | 20 | - | 2 | 2.6 | 20 | AlInGaP on GaAs |
| VLMKE3401-GS08 | Red | 71 | - | 140 | 20 | - | 630 | - | 20 | - | 1.9 | 2.6 | 20 | AlInGaP on GaAs |
| VLMKE3401-GS08 | Yellow | 112 | - | 224 | 20 | 581 | 588 | 594 | 20 | - | 2 | 2.6 | 20 | AlInGaP on GaAs |
| VLMKE3401-GS18 | Red | 71 | - | 140 | 20 | - | 630 | - | 20 | - | 1.9 | 2.6 | 20 | AlInGaP on GaAs |
| VLMKE3401-GS18 | Yellow | 112 | - | 224 | 20 | 581 | 588 | 594 | 20 | - | 2 | 2.6 | 20 | AlInGaP on GaAs |

**ABSOLUTE MAXIMUM RATINGS** ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)
VLMKE3400, VLMKE3401

| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
|--|---|------------|------------------------------------|--------------------|
| Reverse voltage per diode | | V_R | Not designed for reverse operation | V |
| DC forward current per diode | $T_{amb} \leq 80\text{ }^{\circ}\text{C}$, 1 chip on | I_F | 30 | mA |
| Surge forward current per diode | $t_p \leq 10\text{ }\mu\text{s}$ | I_{FSM} | 0.1 | A |
| Power dissipation per diode | | P_V | 80 | mW |
| Junction temperature | | T_j | 125 | $^{\circ}\text{C}$ |
| Operating temperature range | | T_{amb} | -40 to +100 | $^{\circ}\text{C}$ |
| Storage temperature range | | T_{stg} | -40 to +100 | $^{\circ}\text{C}$ |
| Thermal resistance junction to ambient | Mounted on PC board (pad size > 16 mm ²) | R_{thJA} | 560 | K/W |

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)
VLMKE3400, VLMKE3401, RED

| PARAMETER | TEST CONDITION | PART | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|-------------------------|---|-----------|-------------|------|----------|------|------------|
| Luminous intensity | $I_F = 20\text{ mA}$ | VLMKE3400 | I_V | 56 | - | 180 | mcd |
| | | VLMKE3401 | I_V | 71 | - | 140 | mcd |
| Dominant wavelength | $I_F = 20\text{ mA}$ | | λ_d | - | 630 | - | nm |
| Peak wavelength | $I_F = 20\text{ mA}$ | | λ_p | - | 643 | - | nm |
| Angle of half intensity | $I_F = 20\text{ mA}$ | | ϕ | - | ± 60 | - | $^{\circ}$ |
| Forward voltage | $I_F = 20\text{ mA}$ | | V_F | - | 1.9 | 2.6 | V |
| Reverse voltage | $I_R = 10\text{ }\mu\text{A}$ | | V_R | 6 | - | - | V |
| Junction capacitance | $V_R = 0\text{ V}$, $f = 1\text{ MHz}$ | | C_j | - | 15 | - | pF |

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)
VLMKE3400, VLMKE3401, YELLOW

| PARAMETER | TEST CONDITION | PART | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|-------------------------|---|-----------|-------------|------|----------|------|------------|
| Luminous intensity | $I_F = 20\text{ mA}$ | VLMKE3400 | I_V | 90 | - | 280 | mcd |
| | | VLMKE3401 | I_V | 112 | - | 224 | mcd |
| Dominant wavelength | $I_F = 20\text{ mA}$ | | λ_d | 581 | 588 | 594 | nm |
| Peak wavelength | $I_F = 20\text{ mA}$ | | λ_p | - | 590 | - | nm |
| Angle of half intensity | $I_F = 20\text{ mA}$ | | ϕ | - | ± 60 | - | $^{\circ}$ |
| Forward voltage | $I_F = 20\text{ mA}$ | | V_F | - | 2 | 2.6 | V |
| Reverse voltage | $I_R = 10\text{ }\mu\text{A}$ | | V_R | 6 | - | - | V |
| Junction capacitance | $V_R = 0\text{ V}$, $f = 1\text{ MHz}$ | | C_j | - | 15 | - | pF |

**LUMINOUS INTENSITY CLASSIFICATION AND GROUP COMBINATIONS
VLMKE34..**

| | | RED | | | | |
|----------------------------|--------------------------|------------------------|------------------------|-------------------------|--------------------------|-------------------------|
| | | P2 56 mcd to 71 mcd | Q1 71 mcd to 90 mcd | Q2 90 mcd to 112 mcd | R1 112 mcd to 140 mcd | R2 140 mcd to 80 mcd |
| Y E L L O W | Q2 90 mcd to 112 mcd | 00 | 00 | 00 | 00 | 00 |
| | R1 112 mcd to 140 mcd | 00 | 00 01 | 00 01 | 00 01 | 00 |
| | R2 140 mcd to 180 mcd | 00 | 00 01 | 00 01 | 00 01 | 00 |
| | S1 180 mcd to 224 mcd | 00 | 00 01 | 00 01 | 00 01 | 00 |
| | S2 224 mcd to 280 mcd | 00 | 00 | 00 | 00 | 00 |

Notes

- Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of $\pm 11\%$. The above type numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel). In order to ensure availability, single brightness groups will not be orderable. In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped on any one reel. In order to ensure availability, single wavelength groups will not be orderable.

(1) Followed by 00 or 01

COLOR CLASSIFICATION

| GROUP | DOMINANT WAVELENGTH (nm) | |
|-------|--------------------------|------|
| | YELLOW | |
| | MIN. | MAX. |
| 1 | 581 | 584 |
| 2 | 583 | 586 |
| 3 | 585 | 588 |
| 4 | 587 | 590 |
| 5 | 589 | 592 |
| 6 | 591 | 594 |

Note

- Wavelengths are tested at a current pulse duration of 25 ms

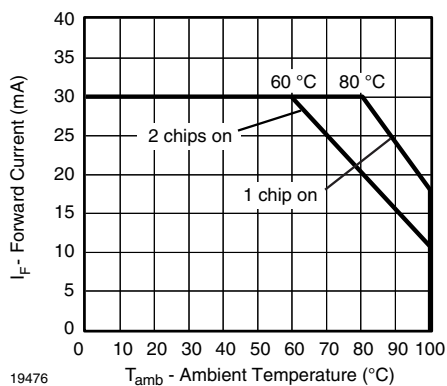
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 1 - Forward Current vs. Ambient Temperature for InGaN

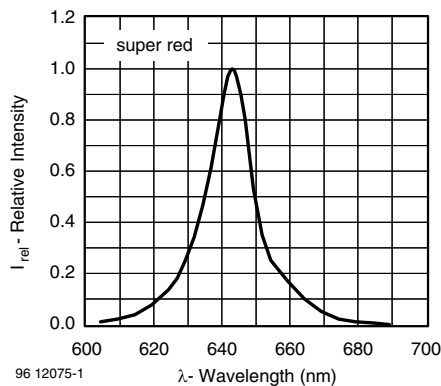


Fig. 4 - Relative Intensity vs. Wavelength

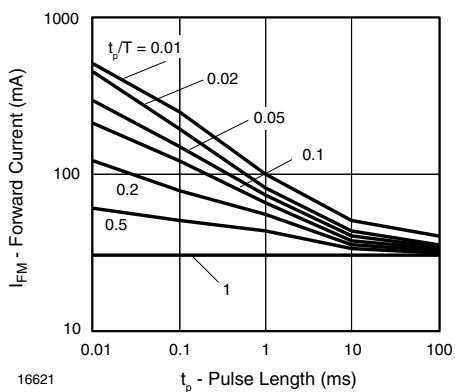


Fig. 2 - Forward Current vs. Pulse Duration

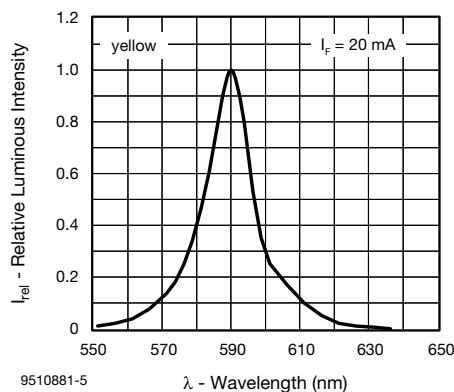


Fig. 5 - Relative Intensity vs. Wavelength

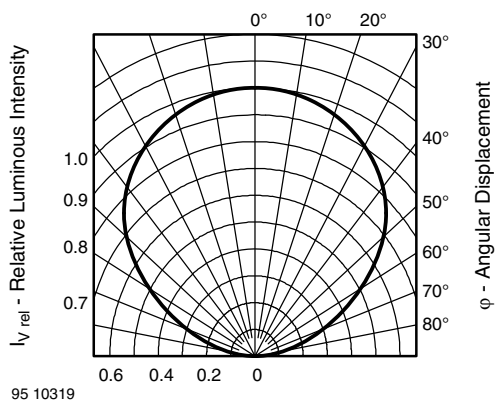


Fig. 3 - Relative Luminous Intensity vs. Angular Displacement

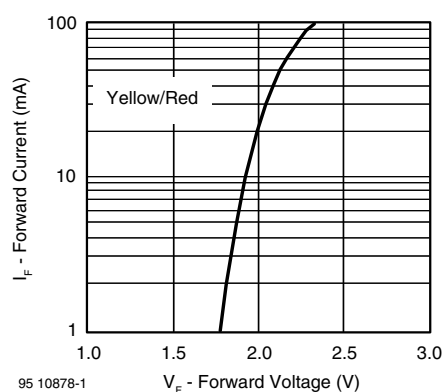


Fig. 6 - Forward Current vs. Forward Voltage

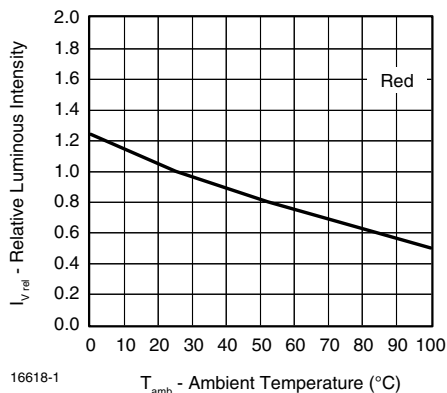


Fig. 7 - Relative Luminous Intensity vs. Ambient Temperature

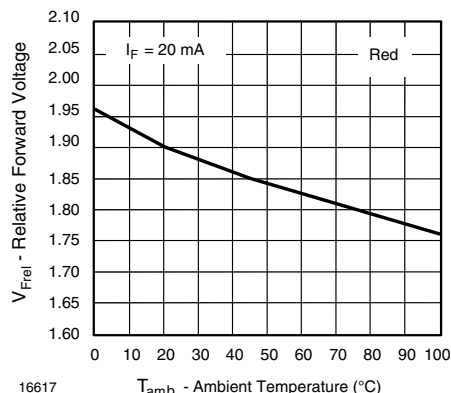


Fig. 10 - Relative Forward Voltage vs. Ambient Temperature

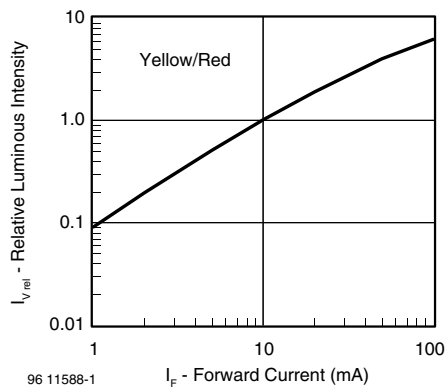


Fig. 8 - Relative Luminous Intensity vs. Forward Current

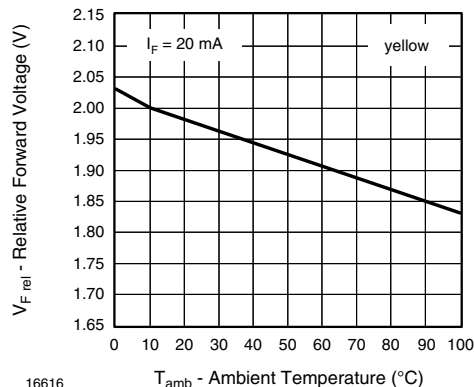


Fig. 11 - Relative Forward Voltage vs. Ambient Temperature

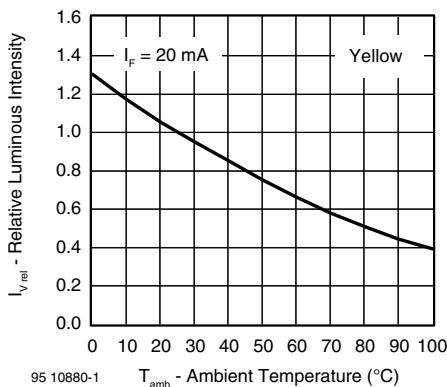
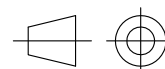
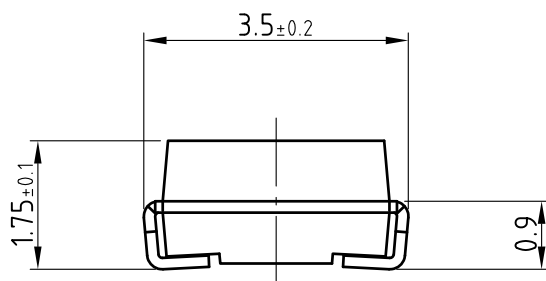


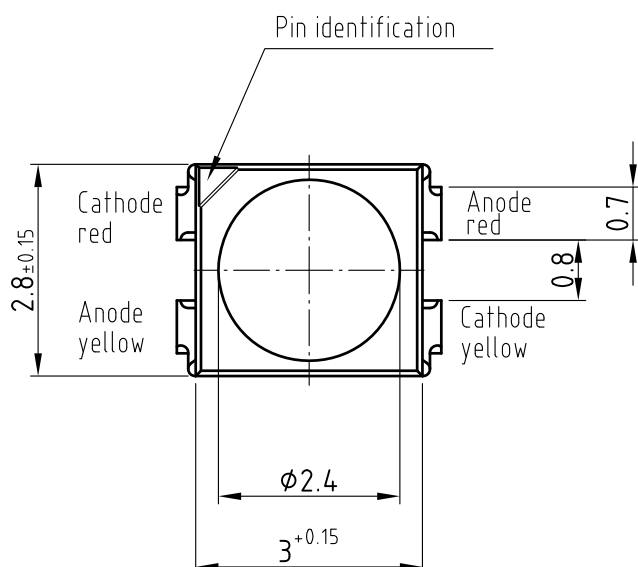
Fig. 9 - Relative Luminous Intensity vs. Ambient Temperature



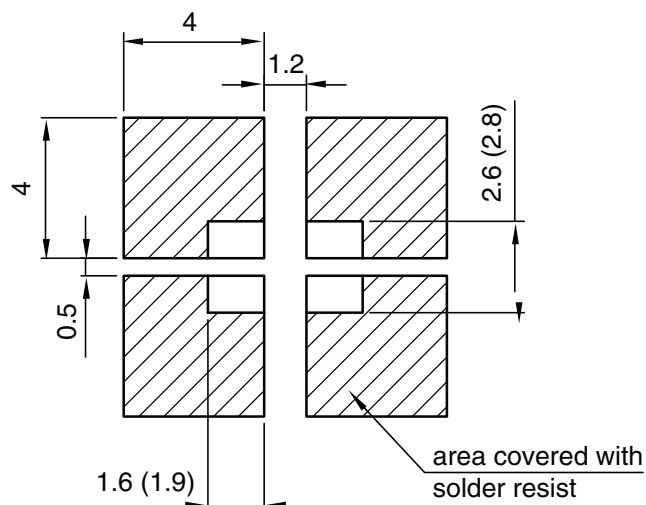
PACKAGE DIMENSIONS in millimeters



technical drawings
according to DIN
specifications



Mounting Pad Layout



Dimensions: IR and Vaporphase
(Wave Soldering)

Drawing-No.: 6.541-5057.01-4

Issue: 5; 30.05.07

19899

PACKING INFORMATION

| PART | PIECES PER REEL | REELS PER BOX | MOQ ⁽¹⁾ |
|----------------|-----------------|---------------|--------------------|
| VLMKE34xx-GS08 | 1500 | 5 | 7500 |
| VLMKE34xx-GS18 | 8000 | 1 | 8000 |

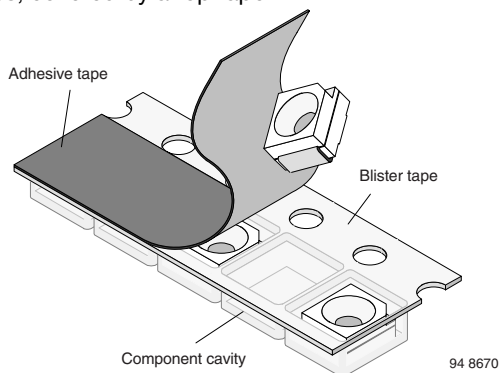
Note

⁽¹⁾ MOQ = minimum order quantity

METHOD OF TAPING / POLARITY AND TAPE AND REEL

SMD LED (VLM.3 - SERIES)

Vishay's LEDs in SMD packages are available in an antistatic 8 mm blister tape (in accordance with DIN IEC 40 (CO) 564) for automatic component insertion. The blister tape is a plastic strip with impressed component cavities, covered by a top tape.



TAPING OF VLM.3...

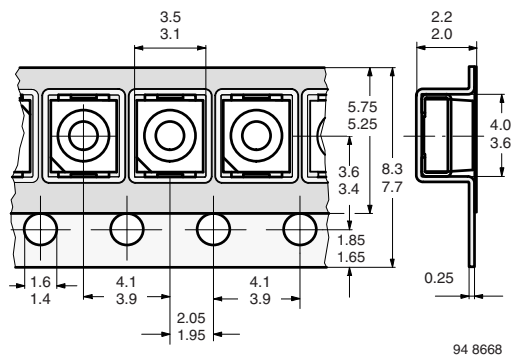


Fig. 12 - Tape Dimensions in mm for PLCC-2

REEL PACKAGE DIMENSION IN MILLIMETERS FOR SMD LED, TAPE OPTION GS08 (= 1500 PCS.)

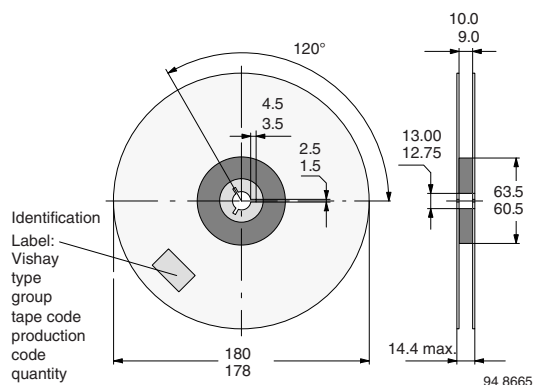


Fig. 13 - Reel Dimensions - GS08

REEL PACKAGE DIMENSION IN MILLIMETERS FOR SMD LED, TAPE OPTION GS18 (= 8000 PCS.) PREFERRED

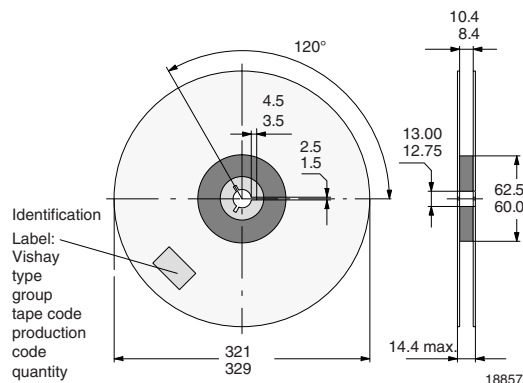


Fig. 14 - Reel Dimensions - GS18

SOLDERING PROFILE

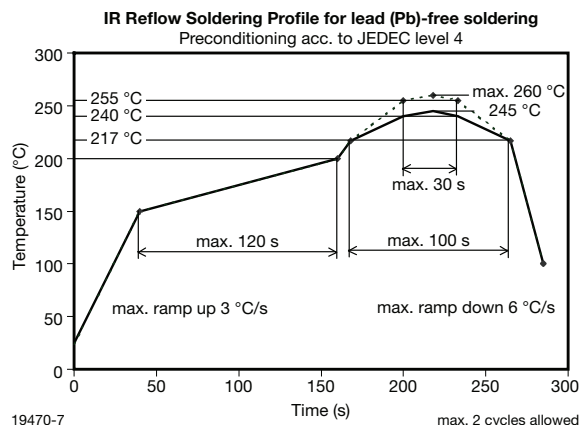


Fig. 15 - Vishay Lead (Pb)-free Reflow Soldering Profile (according to J-STD-020)

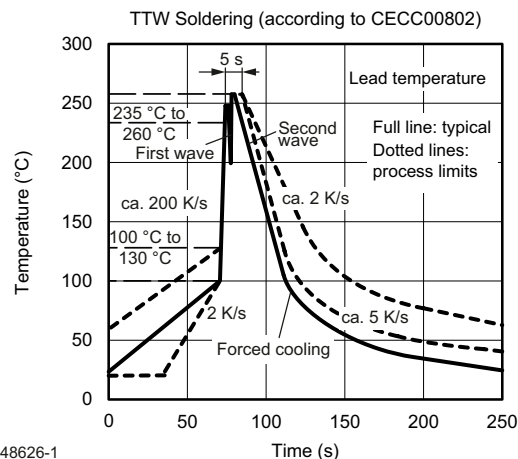
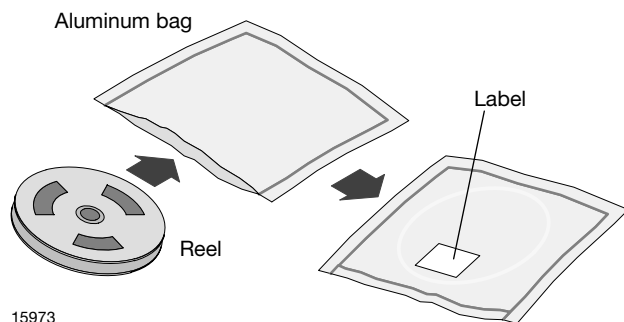


Fig. 16 - Double Wave Soldering of Opto Devices (all Packages)

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

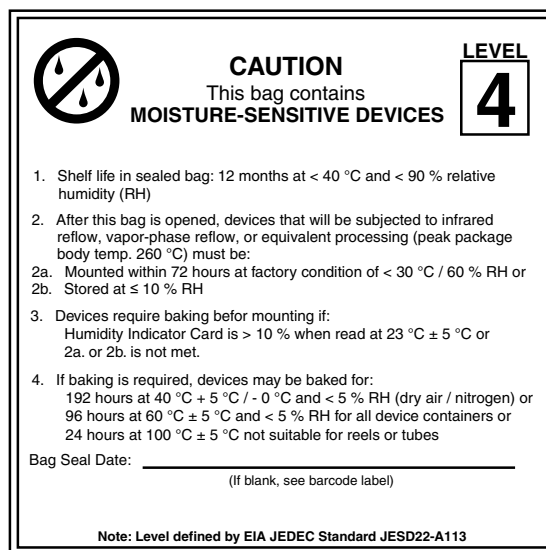
- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or
 96 h at 60 °C + 5 °C and < 5 % RH for all device containers or
 24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC standard JESD22-A112 level 4 label is included on all dry bags.



22860

Example of JESD22-A112 level 4 label

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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